## RP321015-ASC3

## SMD Type Red Emitter

### Features

- Side view 1204 package
- Viewing Angle =  $\pm 60^{\circ}$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Red
- RoHS compliance

### Applications

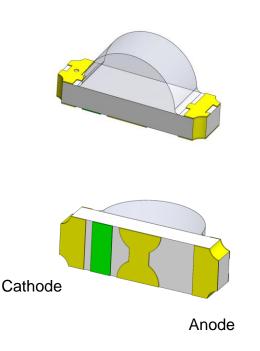
- Optical indicator.
- Switch and Symbol Display.

### Description

**Schematic** 

The RP321015-ASC3 is an AlGaInP Red LED housed in a miniature SMD package. The device has a dominant wavelength of 620 nm LED.

### **Package Outline**







### Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	25	mA	
IFP	Peak Forward Current	60	mA	1
V <sub>R</sub>	Reverse Voltage	5	V	
T <sub>opr</sub>	Operating Temperature	-40 ~ +85	٥C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	٥C	
T <sub>sol</sub>	Soldering Temperature	260	0C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	65	mW	

#### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

#### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =20mA	62	-	200	mcd	3
$\lambda_{D}$	Dominant Wavelength	I <sub>F</sub> =20mA	615	-	630	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =20mA	-	±60	-	deg	

#### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =20mA	1.7	-	2.5	V	5
IR	Reverse Current	V <sub>R</sub> =5V	-	-	1	μA	

Notes:

- 1. IFP Conditions--Pulse Width  $\leq 100 \mu s$  and Duty  $\leq 10\%.$
- 2. Soldering time  $\leq 10$  seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
m	62	89		
n	89	130	mcd	I⊧=20mA
о	130	200		

Tolerance of Luminous Intensity  $\pm 10\%$ 



#### 4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition
J1	615	620		
J2	620	625	nm	I⊧=20mA
J3	625	630		

Tolerance of Dominant Wavelength: ±1nm.

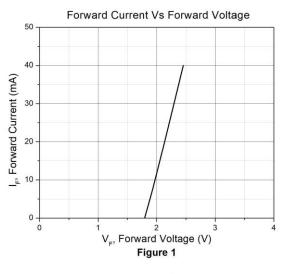
#### 5. Bin Range of Forward Voltage

Bin Code	Min	Max	Unit	Condition
V4	1.7	1.9		
V5	1.9	2.1	V	
V6	2.1	2.3	V	l⊧=20mA
V7	2.3	2.5		

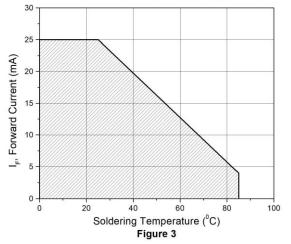
Tolerance of Forward Voltage  $\pm 0.1$  V.



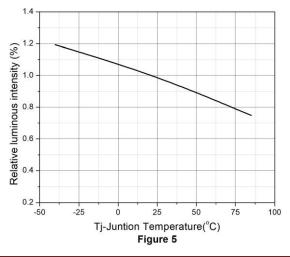
### **Typical Characteristic Curves**

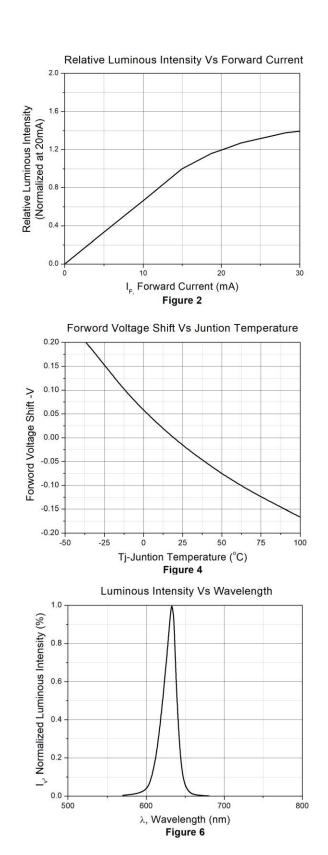


Forward Current Vs Soldering Temperature



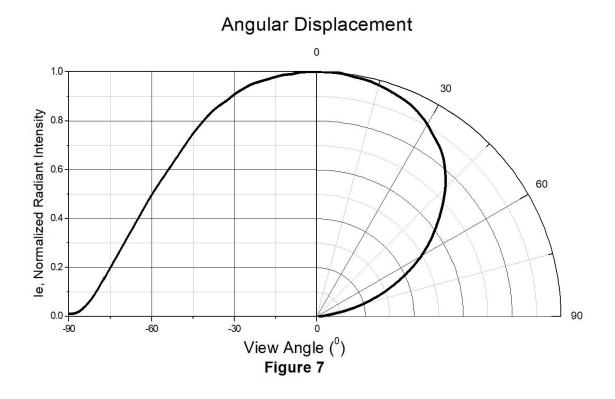
Relative Luminous Intensity Vs Juntion Temperature



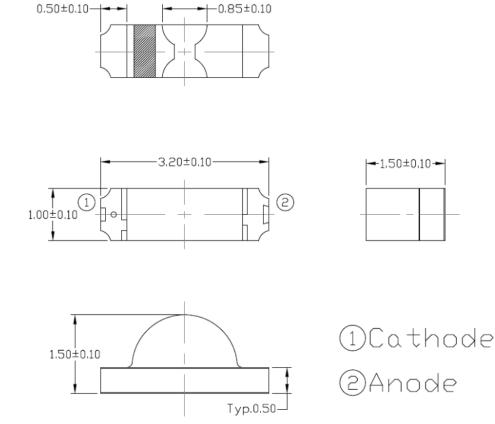




## **Typical Characteristic Curves**



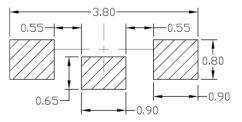




### Package Dimension All dimensions are in mm, unless otherwise stated

Note: Tolerance unless mentioned is  $\pm 0.1$ mm.

### Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



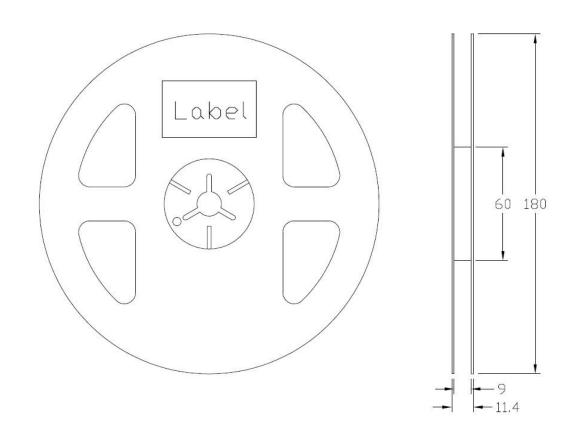
Note: Tolerance unless mentioned is ±0.1mm.

### **Ordering Information**

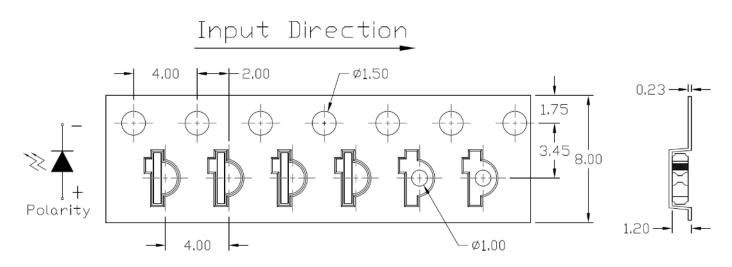
Part Number	Description	Quantity
RP321015-ASC3	Tape & Reel	3000 pcs



### Reel Dimension All dimensions are in mm, unless otherwise stated



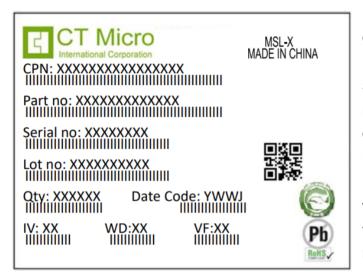
#### Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



### Label Form Specification



CPN : Customer Part Number Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date IV : Bin Code of Luminous Intensity WD : Bin Code of Dominant Wavelength VF : Bin Code of Forward Voltage MADE IN CHINA: Production Place

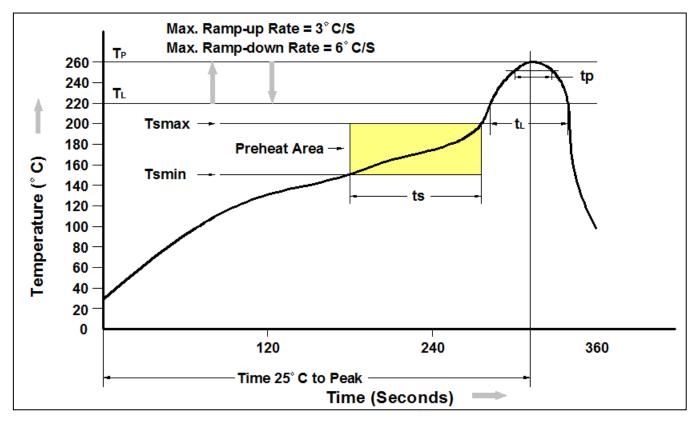
### **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



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### **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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